

MC74VHC1GT14DFT2G Datasheet



DiGi Electronics Part Number

Manufacturer

Manufacturer Product Number

Description

Detailed Description

MC74VHC1GT14DFT2G-DG

onsemi

MC74VHC1GT14DFT2G

IC INVERT SCHMITT 1CH 1INP SC88A

Inverter IC 1 Channel Schmitt Trigger SC-88A (SC-70 -5/SOT-353)

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Purchase and inquiry

| Manufacturer Product Number: | Manufacturer: |
|------------------------------|------------------------------------|
| MC74VHC1GT14DFT2G | onsemi |
| Series: | Product Status: |
| 74VHC | Active |
| Logic Type: | Number of Circuits: |
| Inverter | 1 |
| Number of Inputs: | Features: |
| 1 | Schmitt Trigger |
| Voltage - Supply: | Current - Quiescent (Max): |
| 2V ~ 5.5V | 1 μΑ |
| Current - Output High, Low: | Input Logic Level - Low: |
| 8mA, 8mA | 1.5V ~ 2.9V |
| Input Logic Level - High: | Max Propagation Delay @ V, Max CL: |
| 2.2V ~ 3.85V | 10.6ns @ 5V, 50pF |
| Operating Temperature: | Mounting Type: |
| -55°C ~ 125°C | Surface Mount |
| Supplier Device Package: | Package / Case: |
| SC-88A (SC-70-5/SOT-353) | 5-TSSOP, SC-70-5, SOT-353 |
| | |

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Single Schmitt-Trigger Inverter

MC74VHC1G14, MC74VHC1GT14

The MC74VHC1G14 / MC74VHC1GT14 is a single Schmitt-Trigger Inverter in tiny footprint packages. The MC74VHC1G14 has CMOS-level input thresholds while the MC74VHC1GT14 has TTL-level input thresholds.

The internal circuit is composed of three stages, including a buffered output which provides high noise immunity and stable output.

The input structures provide protection when voltages up to 5.5 V are applied, regardless of the supply voltage. This allows the device to be used to interface 5 V circuits to 3 V circuits. Some output structures also provide protection when $V_{CC} = 0$ V and when the output voltage exceeds V_{CC} . These input and output structures help prevent device destruction caused by supply voltage – input/output voltage mismatch, battery backup, hot insertion, etc.

Features

- Designed for 2.0 V to 5.5 V V_{CC} Operation
- 4.0 ns t_{PD} at 5 V (typ)
- Inputs/Outputs Over-Voltage Tolerant up to 5.5 V
- IOFF Supports Partial Power Down Protection
- Source/Sink 8 mA at 3.0 V
- Available in SC-88A, SC-74A, TSOP-5, SOT-953 and UDFN6 Packages
- Chip Complexity < 100 FETs
- -Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

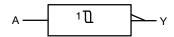


Figure 1. Logic Symbol

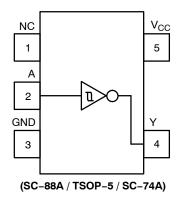
| ST.R. | SC-88A DF SUFFIX CASE 419A | MARKING DIAGRAMS |
|---|--|---------------------------|
| - AND | SC-74A DBV SUFFIX CASE 318BQ | XXX M• • • |
| 5 | TSOP-5 DT SUFFIX CASE 483 | |
| | | XXXAYW- ● • 1 □ □ □ |
| and a second | SOT-953 P5 SUFFIX CASE 527AE | |
| | UDFN6 1.45 x 1.0 CASE 517AQ | ▲ XM |
| | UDFN6 1.2 x 1.0 CASE 517AA | × M • |
| Ŷ | UDFN6 1.0 x 1.0 CASE 517BX | 1 • X M |
| XX M • | = Specific Device = Date Code* = Pb-Free Packs | age |

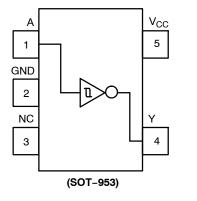
(Note: Microdot may be in either location)

*Date Code orientation and/or position may vary depending upon manufacturing location.

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 7 of this data sheet.





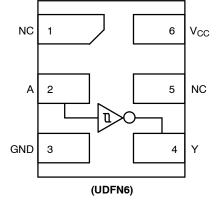


Figure 2. Pinout (Top View)

PIN ASSIGNMENT

(SC-88A / TSOP-5 / SC-74A)

| Pin | Function |
|-----|-----------------|
| 1 | NC |
| 2 | A |
| 3 | GND |
| 4 | Y |
| 5 | V _{CC} |

PIN ASSIGNMENT (SOT-953)

| Pin | Function |
|-----|-----------------|
| 1 | А |
| 2 | GND |
| 3 | NC |
| 4 | Y |
| 5 | V _{CC} |
| | |

PIN ASSIGNMENT (UDFN)

| Pin | Function |
|-----|-----------------|
| 1 | NC |
| 2 | A |
| 3 | GND |
| 4 | Y |
| 5 | NC |
| 6 | V _{CC} |

FUNCTION TABLE

| A Input | Y Output |
|---------|----------|
| L | н |
| Н | L |

MAXIMUM RATINGS

| Symbol | Characteristics | | Value | Unit |
|-------------------------------------|--|--|---|------|
| V _{CC} | DC Supply Voltage | | -0.5 to +6.5 | V |
| V _{IN} | DC Input Voltage | | -0.5 to +6.5 | V |
| V _{OUT} | | lode (High or Low State) Tri-State Mode (Note 1) Down Mode (V _{CC} = 0 V) | -0.5 to V _{CC} + 0.5 -0.5 to +6.5 -0.5 to +6.5 | V |
| I _{IK} | DC Input Diode Current | V _{IN} < GND | -20 | mA |
| I _{OK} | DC Output Diode Current | V _{OUT} < GND | -20 | mA |
| I _{OUT} | DC Output Source/Sink Current | | ±25 | mA |
| I _{CC} or I _{GND} | DC Supply Current per Supply Pin or Ground Pin | | ±50 | mA |
| T _{STG} | Storage Temperature Range | | -65 to +150 | °C |
| ΤL | Lead Temperature, 1 mm from Case for 10 secs | | 260 | °C |
| TJ | Junction Temperature Under Bias | | +150 | °C |
| θ_{JA} | Thermal Resistance (Note 2) | SC-88A SC-74A SOT-953 UDFN6 | 377 320 254 154 | °C/W |
| P _D | Power Dissipation in Still Air | SC-88A SC-74A SOT-953 UDFN6 | 332 390 491 812 | mW |
| MSL | Moisture Sensitivity | | Level 1 | - |
| F _R | Flammability Rating | Oxygen Index: 28 to 34 | UL 94 V-0 @ 0.125 in | - |
| V_{ESD} | ESD Withstand Voltage (Note 3) | Human Body Model Charged Device Model | 2000 1000 | V |
| I _{Latchup} | Latchup Performance (Note 4) | | ±100 | mA |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Applicable to devices with outputs that may be tri-stated.

 Measured with minimum pad spacing on an FR4 board, using 10mm-by-1inch, 2 ounce copper trace no air flow per JESD51-7.
 HBM tested to ANSI/ESDA/JEDEC JS-001-2017. CDM tested to EIA/JESD22-C101-F. JEDEC recommends that ESD qualification to EIA/JESD22-A115-A (Machine Model) be discontinued per JEDEC/JEP172A.

4. Tested to EIA/JESD78 Class II.

RECOMMENDED OPERATING CONDITIONS

| Symbol | Characteristics | Min | Max | Unit |
|---------------------------------|--|------------------|--|------|
| V _{CC} | Positive DC Supply Voltage | 2.0 | 5.5 | V |
| V _{IN} | DC Input Voltage | 0 | 5.5 | V |
| V _{OUT} | DC Output Voltage Active–Mode (High or Low State) Tri–State Mode (Note 5) Power–Down Mode (V _{CC} = 0 V) | 0 0 0 | V _{CC} 5.5 5.5 | V |
| T _A | Operating Temperature Range | -55 | +125 | °C |
| t _r , t _f | Input Rise and Fall Time $V_{CC} = 2.0 \text{ V}$ $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | 0 0 0 0 | No Limit No Limit No Limit No Limit | ns/V |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

5. Applicable to devices with outputs that may be tri-stated.

| | | Test | v _{cc} | ٦ | T _A = 25°C | | | T _A ≤ 85°C | -55 °C ≤ T | A ≤ 125°C | |
|------------------|-------------------------------------|---|---------------------------------|-----------------------------------|-----------------------------|----------------------------|-----------------------------------|-----------------------------------|-----------------------------------|----------------------------|------|
| Symbol | Parameter | Conditions | (V) | Min | Тур | Max | Min | Max | Min | Max | Unit |
| V_{T+} | Positive Input Threshold Voltage | | 3.0 4.5 5.5 | - - - | 2.0 3.0 3.6 | 2.2 3.15 3.85 | - - - | 2.2 3.15 3.85 | - - - | 2.2 3.15 3.85 | V |
| V _{T-} | Negative Input Threshold Voltage | | 3.0 4.5 5.5 | 0.9 1.35 1.65 | 1.5 2.3 2.9 | - - - | 0.9 1.35 1.65 | - - - | 0.9 1.35 1.65 | - - - | V |
| V _H | Hysteresis Voltage | | 3.0 4.5 5.5 | 0.30 0.40 0.50 | 0.57 0.67 0.74 | 1.20 1.40 1.60 | 0.30 0.40 0.50 | 1.20 1.40 1.60 | 0.30 0.40 0.50 | 1.20 1.40 1.60 | V |
| V _{OH} | High-Level Output Voltage | $\begin{array}{l} V_{IN} = V_{IH} \text{ or } V_{IL} \\ I_{OH} = -50 \ \mu\text{A} \\ I_{OH} = -50 \ \mu\text{A} \\ I_{OH} = -50 \ \mu\text{A} \\ I_{OH} = -4 \ m\text{A} \\ I_{OH} = -8 \ m\text{A} \end{array}$ | 2.0 3.0 4.5 3.0 4.5 | 1.9 2.9 4.4 2.58 3.94 | 2.0 3.0 4.5 – | - - - - | 1.9 2.9 4.4 2.48 3.80 | - - - - | 1.9 2.9 4.4 2.34 3.66 | - - - - | V |
| V _{OL} | Low-Level Output Voltage | | 2.0 3.0 4.5 3.0 4.5 | - - - - | 0.0 0.0 0.0 - - | 0.1 0.1 0.36 0.36 | - - - - | 0.1 0.1 0.1 0.44 0.44 | - - - - | 0.1 0.1 0.52 0.52 | V |
| I _{IN} | Input Leakage Current | V _{IN} = 5.5 V or GND | 2.0 to 5.5 | - | - | ±0.1 | - | ±1.0 | - | ±1.0 | μΑ |
| I _{OFF} | Power Off Leakage Current | V _{IN} = 5.5 V or V _{OUT} = 5.5 V | 0.0 | - | - | 1.0 | _ | 10 | - | 10 | μΑ |
| I _{CC} | Quiescent Supply Current | V _{IN} = V _{CC} or GND | 5.5 | - | - | 1.0 | - | 20 | - | 40 | μΑ |

DC ELECTRICAL CHARACTERISTICS (MC74VHC1G14)

| | | Test | v _{cc} | T _A = 25°C | | | $-40^\circ C \le T_A \le 85^\circ C$ | | $-55^\circ C \le T_A \le 125^\circ C$ | | | |
|------------------|---|--|---------------------------------|-----------------------------------|------------------------|----------------------------|--------------------------------------|----------------------------|---------------------------------------|----------------------------|------|--|
| Symbol | Parameter | Conditions | (V) | Min | Тур | Max | Min | Max | Min | Max | Unit | |
| V _{T+} | Positive Input Threshold Voltage | | 3.0 4.5 5.5 | - - - | 1.4 1.74 1.94 | 1.6 2.0 2.1 | - - - | 1.6 2.0 2.1 | - - - | 1.6 2.0 2.1 | V | |
| V _{T-} | Negative Input Threshold Voltage | | 3.0 4.5 5.5 | 0.35 0.5 0.6 | 0.76 1.01 1.13 | - - - | 0.35 0.5 0.6 | - - | 0.35 0.5 0.6 | - - - | V | |
| V _H | Hysteresis Voltage | | 3.0 4.5 5.5 | 0.30 0.40 0.50 | 0.64 0.73 0.81 | 1.20 1.40 1.60 | 0.30 0.40 0.50 | 1.20 1.40 1.60 | 0.30 0.40 0.50 | 1.20 1.40 1.60 | V | |
| V _{OH} | High-Level Output Voltage | | 2.0 3.0 4.5 3.0 4.5 | 1.9 2.9 4.4 2.58 3.94 | 2.0 3.0 4.5 – | - - - - | 1.9 2.9 4.4 2.48 3.80 | - - - - | 1.9 2.9 4.4 2.34 3.66 | - - - - | V | |
| V _{OL} | Low-Level Output Voltage | | 2.0 3.0 4.5 3.0 4.5 | - - - - | 0.0 0.0 0.0 - | 0.1 0.1 0.36 0.36 | - - - - | 0.1 0.1 0.44 0.44 | - - - - - | 0.1 0.1 0.52 0.52 | V | |
| I _{IN} | Input Leakage Current | V _{IN} = 5.5 V or GND | 2.0 to 5.5 | - | - | ±0.1 | _ | ±1.0 | - | ±1.0 | μA | |
| I _{OFF} | Power Off Leakage Current | V _{IN} = 5.5 V or V _{OUT} = 5.5 V | 0 | - | - | 1.0 | - | 10 | - | 10 | μA | |
| ICC | Quiescent Supply Current | V _{IN} = V _{CC} or GND | 5.5 | - | - | 1.0 | - | 20 | - | 40 | μΑ | |
| I _{CCT} | Increase in Quiescent Supply Current per Input Pin | One Input: V _{IN} = 3.4 V; Other Input at V _{CC} or GND | 5.5 | - | - | 1.35 | - | 1.5 | - | 1.65 | mA | |

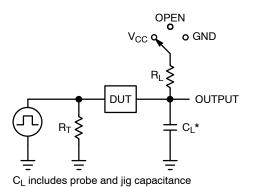
DC ELECTRICAL CHARACTERISTICS (MC74VHC1GT14)

AC ELECTRICAL CHARACTERISTICS

| | | | | T _A = 25°C | | –40°C ≤ 1 | Γ _A ≤ 85°C | –55°C ≤ T | | | |
|--------------------|-----------------------------|---|---------------------|-----------------------|-----|-----------|-----------------------|-----------|-----|------|------|
| Symbol | Parameter | Conditions | V _{CC} (V) | Min | Тур | Max | Min | Max | Min | Max | Unit |
| t _{PLH} , | Propagation Delay, | C _L = 15 pF | 3.0 to 3.6 | - | 7.0 | 12.8 | - | 15.0 | - | 17.0 | ns |
| t _{PHL} | A to Y (Figures 3 and 4) | C _L = 50 pF | | - | 8.5 | 16.3 | - | 18.5 | - | 20.5 | |
| | (gai ee e aira .) | C _L = 15 pF | 4.5 to 5.5 | - | 4.0 | 8.6 | - | 10.0 | - | 11.5 | |
| | | C _L = 50 pF | | - | 5.5 | 10.6 | - | 12.0 | - | 13.5 | |
| C _{IN} | Input Capacitance | | | - | 4.0 | 10 | - | 10 | - | 10 | pF |
| C _{OUT} | Output Capacitance | Output in High Impedance State | | - | 6.0 | - | _ | _ | _ | _ | pF |

| | | Typical @ 25°C, V_{CC} = 5.0 V | |
|-----------------|--|----------------------------------|----|
| C _{PD} | Power Dissipation Capacitance (Note 6) | 8.0 | pF |

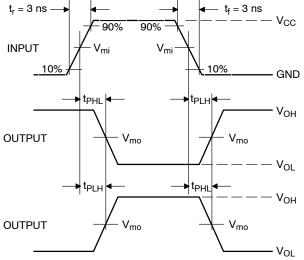
6. C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I_{CC(OPR)} = C_{PD} ● V_{CC} ● f_{in} + I_{CC}. C_{PD} is used to determine the no-load dynamic power consumption; P_D = C_{PD} ● V_{CC}² ● f_{in} + I_{CC} ● V_{CC}.



| Test | Switch Position | C _L , pF | R_L, Ω |
|-------------------------------------|--------------------|------------------------------|---------------|
| t _{PLH} / t _{PHL} | Open | See AC Characteristics Table | Х |
| t _{PLZ} / t _{PZL} | V _{CC} | | 1 k |
| t _{PHZ} / t _{PZH} | GND | | 1 k |

X = Don't Care

R_T is Z_{OUT} of pulse generator (typically 50 Ω) f = 1 MHz Figure 3. Test Circuit



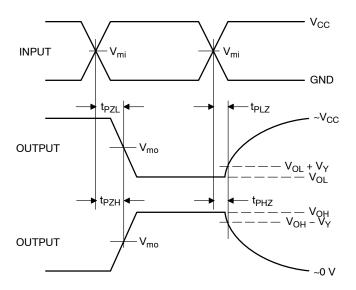


Figure 4. Switching Waveforms

| | | V _{mo} , V | | |
|---------------------|---------------------|-------------------------------------|---|--------------------|
| V _{CC} , V | V _{mi} , V | t _{PLH} , t _{PHL} | t _{PZL} , t _{PLZ} , t _{PZH} , t _{PHZ} | V _Y , V |
| 3.0 to 3.6 | V _{CC} /2 | V _{CC} /2 | V _{CC} /2 | 0.3 |
| 4.5 to 5.5 | V _{CC} /2 | V _{CC} /2 | V _{CC} /2 | 0.3 |

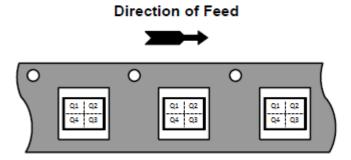
ORDERING INFORMATION

| Device | Packages | Specific Device Code | Pin 1 Orientation (See below) | Shipping [†] |
|---|-------------------------|----------------------|----------------------------------|-----------------------|
| MC74VHC1G14DFT1G | SC-88A | VA | Q2 | 3000 / Tape & Reel |
| MC74VHC1G14DFT2G | SC-88A | VA | Q4 | 3000 / Tape & Reel |
| MC74VHC1G14DFT1G-Q* | SC-88A | VA | Q2 | 3000 / Tape & Reel |
| MC74VHC1G14DFT2G-Q* | SC-88A | VA | Q4 | 3000 / Tape & Reel |
| MC74VHC1GT14DFT1G | SC-88A | VC | Q2 | 3000 / Tape & Reel |
| MC74VHC1GT14DFT2G | SC-88A | VC | Q4 | 3000 / Tape & Reel |
| MC74VHC1GT14DFT1G-Q* | SC-88A | VC | Q2 | 3000 / Tape & Reel |
| MC74VHC1GT14DFT2G-Q* | SC-88A | VC | Q4 | 3000 / Tape & Reel |
| MC74VHC1G14DBVT1G | SC-74A | VA | Q4 | 3000 / Tape & Reel |
| MC74VHC1G14DBVT1G-Q* | SC-74A | VA | Q4 | 3000 / Tape & Reel |
| MC74VHC1GT14DBVT1G | SC-74A | VC | Q4 | 3000 / Tape & Reel |
| MC7VHC1G14DTT1G-Q* (Please contact onsemi) | TSOP-5 | VA | Q4 | 3000 / Tape & Reel |
| MC74VHC1G14P5T5G | SOT-953 | R | Q2 | 8000 / Tape & Reel |
| MC74VHC1GT14P5T5G (Please contact onsemi) | SOT-953 | TBD | Q2 | 8000 / Tape & Reel |
| MC74VHC1G14MU1TCG (Please contact onsemi) | UDFN6, 1.45 x 1.0, 0.5P | TBD | Q4 | 3000 / Tape & Reel |
| MC74VHC1GT14MU1TCG | UDFN6, 1.45 x 1.0, 0.5P | Q | Q4 | 3000 / Tape & Reel |
| MC74VHC1G14MU2TCG (Please contact onsemi) | UDFN6, 1.2 x 1.0, 0.4P | Р | Q4 | 3000 / Tape & Reel |
| MC74VHC1GT14MU2TCG | UDFN6, 1.2 x 1.0, 0.4P | М | Q4 | 3000 / Tape & Reel |
| MC74VHC1G14MU3TCG (Please contact onsemi) | UDFN6, 1.0 x 1.0, 0.35 | TBD | Q4 | 3000 / Tape & Reel |
| MC74VHC1GT14MU3TCG | UDFN6, 1.0 x 1.0, 0.35 | М | Q4 | 3000 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

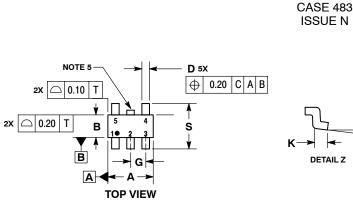
*-Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

Pin 1 Orientation in Tape and Reel



PACKAGE DIMENSIONS

TSOP-5



С 그미

0.05

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SIDE VIEW



DETAIL Z



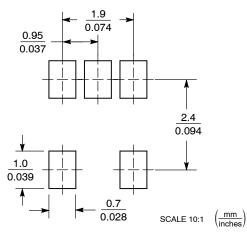
- NOTES:
 DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETERS.
 MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
 DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE. DIMENSION A.
 OPTIONAL CONSTRUCTION: AN ADDITIONAL
- CACED 0.19 PEH SIDE. DIMENSION A. OPTIONAL CONSTRUCTION: AN ADDITIONAL TRIMMED LEAD IS ALLOWED IN THIS LOCATION. TRIMMED LEAD NOT TO EXTEND MORE THAN 0.2 FROM BODY. 5.

| | MILLIMETERS | | | | |
|-----|-------------|------|--|--|--|
| DIM | MIN MAX | | | | |
| Α | 2.85 | 3.15 | | | |
| в | 1.35 | 1.65 | | | |
| С | 0.90 | 1.10 | | | |
| D | 0.25 | 0.50 | | | |
| G | 0.95 BSC | | | | |
| Η | 0.01 | 0.10 | | | |
| L | 0.10 | 0.26 | | | |
| К | 0.20 | 0.60 | | | |
| Μ | 0 ° | 10 ° | | | |
| S | 2.50 | 3.00 | | | |



SOLDERING FOOTPRINT*

END VIEW



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



0.05 C

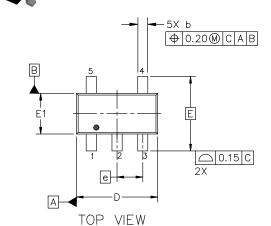
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MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

SC-74A-5 3.00x1.50x0.95, 0.95P CASE 318BQ **ISSUE C**

DATE 26 FEB 2024



(A2)

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L2 GAUGE PLANE

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"A"

SEATING

PLANE

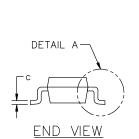
NOTES:

DIMENSIONING AND TOLERANCING CONFORM TO ASME 1. Y14.5-2018.

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1.00

- 2. ALL DIMENSION ARE IN MILLIMETERS (ANGLES IN DEGREES).
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, 4. PROTRUSIONS OF GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE.



| | LNOLLD | 0.10 1 2 | IN OIDE. | |
|----|--------|----------|----------|-------------|
| | DIM | М | LLIMETER | RS |
| | DIN | MIN. | NOM. | MAX. |
| | А | 0.90 | 1.00 | 1.10 |
| | A1 | 0.01 | 0.18 | 0.10 |
| | A2 | (| 0.95 REF | |
| | b | 0.25 | 0.37 | 0.50 |
| | с | 0.10 | 0.18 | 0.26 |
| | D | 2.85 | 3.00 | 3.15 |
| | E | | 2.75 BSC | ; |
| | E1 | 1.35 | 1.50 | 1.65 |
| | е | (| D.95 BSC | ; |
| | L | 0.20 | 0.40 | 0.60 |
| | L1 | (| 0.62 REF | |
| | L2 | (| D.25 BSC | ; |
| | Θ | 0° | 5° | 10 ° |
| | | - | —1.90 | |
| 5— | | | | |
| 0 | | | | |
| | | | | |
| | τiπti | JTJT- | ł | |
| | 1 1 | I | 2.40 |) |
| | | | | |
| | | | | |
| | LII | ЦТ- | | |
| | | | | |



(L1)

DETAIL SCALE 2:1

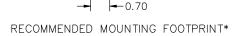
SIDE VIEW

| X | XX M∎ | |
|-------|----------|------|
| 0 | • | |
| | | Γ |
| = Spe | ecific D | evic |

XXX Specific Device Code = Date Code Μ = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " .", may or may not be present. Some products may not follow the Generic Marking.



FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

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|------------------|--|-------|-------------|
| DESCRIPTION: | SC-74A-5 3.00x1.50x0.95, | 0.95P | PAGE 1 OF 1 |

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SC-88A (SC-70-5/SOT-353) CASE 419A-02 ISSUE M

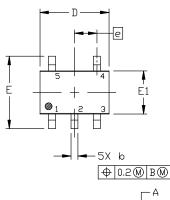
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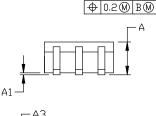
2.

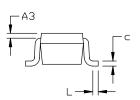
З.

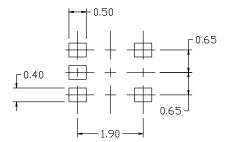
4.

DATE 11 APR 2023









RECOMMENDED MOUNTING FOOTPRINT

 For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

| DIM | MI | LLIMETE | RS |
|-------|----------|---------|------|
| ויונע | MIN. | NDM. | MAX, |
| A | 0.80 | 0.95 | 1.10 |
| A1 | | | 0.10 |
| A3 | 0.20 REF | | |
| b | 0.10 | 0.20 | 0.30 |
| С | 0.10 | | 0.25 |
| D | 1.80 | 2.00 | 2.20 |
| E | 2.00 | 2.10 | 5.20 |
| E1 | 1.15 | 1.25 | 1.35 |
| e | 0.65 BSC | | |
| L | 0.10 | 0.15 | 0.30 |

DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH,

PROTRUSIONS, OR GATE BURRS.MOLD FLASH, PROTRUSIONS,

OR GATE BURRS SHALL NOT EXCEED 0.1016MM PER SIDE.

CONTROLLING DIMENSION: MILLIMETERS 419A-01 DBSDLETE, NEW STANDARD 419A-02

GENERIC MARKING





*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

XXX = Specific Device Code

M = Date Code = Pb-Free Package

(Note: Microdot may be in either location)

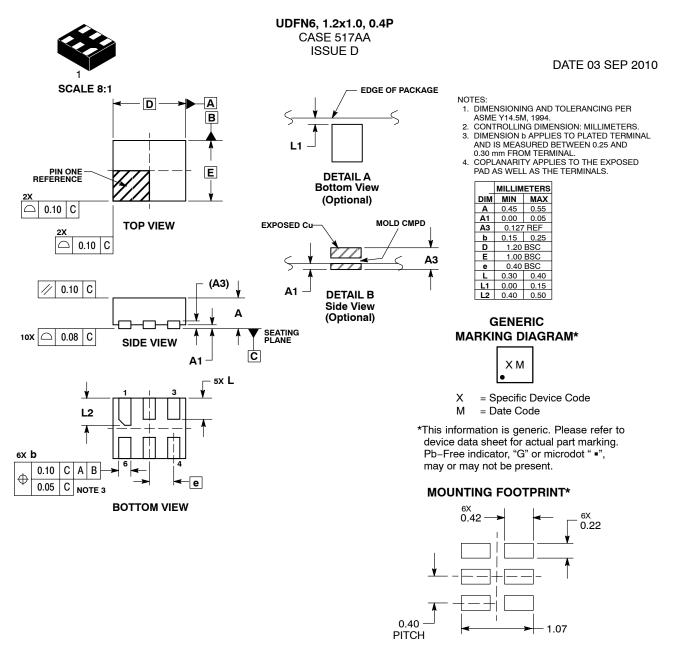
| DESCRIPTION: | SC-88A (SC-70- | 5/SOT-353) | | | PAGE 1 OF 1 |
|--|--|---|--|---|--|
| DOCUMENT NUMBER: | 98ASB42984B | | | ot when accessed directly from when stamped "CONTROLLED | |
| 4. COLLECTOR 5. COLLECTOR STYLE 6: PIN 1. EMITTER 2 2. BASE 2 3. EMITTER 1 4. COLLECTOR 5. COLLECTOR 2/BASE | 4. COLLECTOR 5. CATHODE STYLE 7: PIN 1. BASE 2. EMITTER 3. BASE 4. COLLECTOR 1 5. COLLECTOR | 4. CATHODE 2 5. CATHODE 1 STYLE 8: PIN 1. CATHODE 2. COLLECTOR 3. N/C 4. BASE 5. EMITTER | 4. GATE 1 5. GATE 2 STYLE 9: PIN 1. ANODE 2. CATHODE 3. ANODE 4. ANODE 5. ANODE | 4. CATHODE 3 5. CATHODE 4 Note: Please refer to style callout. If style t out in the datasheet r datasheet pinout or p | ype is not called refer to the device |
| STYLE 1: PIN 1. BASE 2. EMITTER 3. BASE | STYLE 2: PIN 1. ANODE 2. EMITTER 3. BASE | STYLE 3: PIN 1. ANODE 1 2. N/C 3. ANODE 2 | STYLE 4: PIN 1. SOURCE 1 2. DRAIN 1/2 3. SOURCE 1 | STYLE 5: PIN 1. CATHODE 2. COMMON ANOE 3. CATHODE 2 | DE |

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MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS



DIMENSIONS: MILLIMETERS

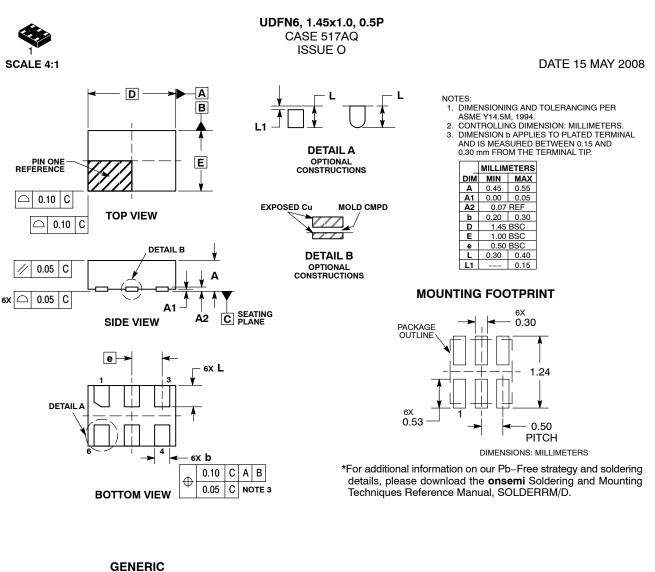
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|--|---------------------------|---|-------------|--|--|
| DESCRIPTION: | 6 PIN UDFN, 1.2X1.0, 0.4P | | PAGE 1 OF 1 | | |
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MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS



MARKING DIAGRAM*



Х

= Specific Device Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " .", may or may not be present.

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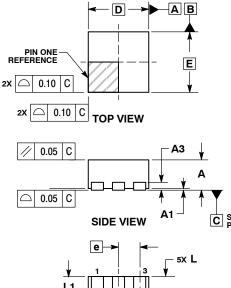


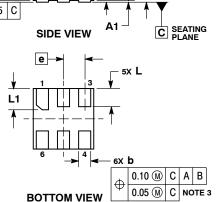
SCALE 4:1

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

UDFN6, 1x1, 0.35P CASE 517BX **ISSUE O**

DATE 18 MAY 2011



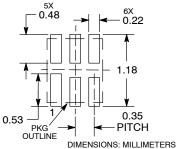


NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

- CONTROLLING DIMENSION: MILLIMETERS. DIMENSION & APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 2. 3
- 0.15 AND 0.20 MM FROM TERMINAL TIP. PACKAGE DIMENSIONS EXCLUSIVE OF 4
- BURRS AND MOLD FLASH.

| | MILLIN | IETERS | |
|-----|----------|--------|--|
| DIM | MIN MAX | | |
| Α | 0.45 | 0.55 | |
| A1 | 0.00 | 0.05 | |
| A3 | 0.13 | REF | |
| b | 0.12 | 0.22 | |
| D | 1.00 BSC | | |
| E | 1.00 BSC | | |
| е | 0.35 | BSC | |
| L | 0.25 | 0.35 | |
| L1 | 0.30 | 0.40 | |

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC **MARKING DIAGRAM***



X = Specific Device Code M = Date Code

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| DESCRIPTION: | UDFN6, 1x1, 0.35P | | PAGE 1 OF 1 | |
| | | | | |

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MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

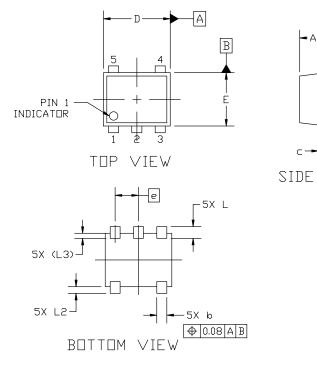


SOT-953 1.00x0.80x0.37, 0.35P CASE 527AE ISSUE F

DATE 17 JAN 2024

NDTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS DF THE BASE MATERIAL.
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.



GENERIC MARKING DIAGRAM*

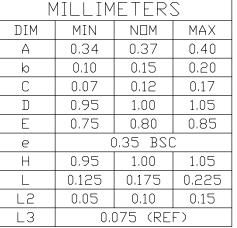


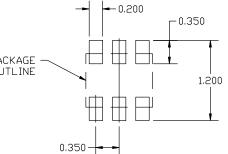
- X = Specific Device Code M = Month Code
- *This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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| DESCRIPTION: | SOT-953 1.00x0.80x0.37, 0.35P | | PAGE 1 OF 1 |
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| | L | | 0.125 | |
|---------------------------|---|----------------|-------|---------------|
| H | | L2 | 0.05 | |
| | | L3 | 0,0 | 57 |
|] t ₊- ∨IEW | | CKAGE TLINE | | .2(]] |





RECOMMENDED MOUNTING FOOTPRINT

*For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

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